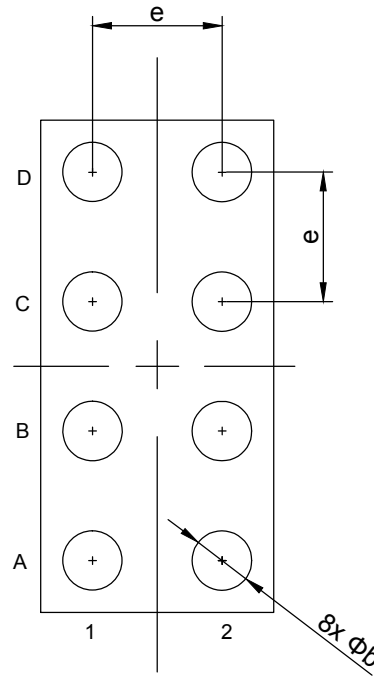
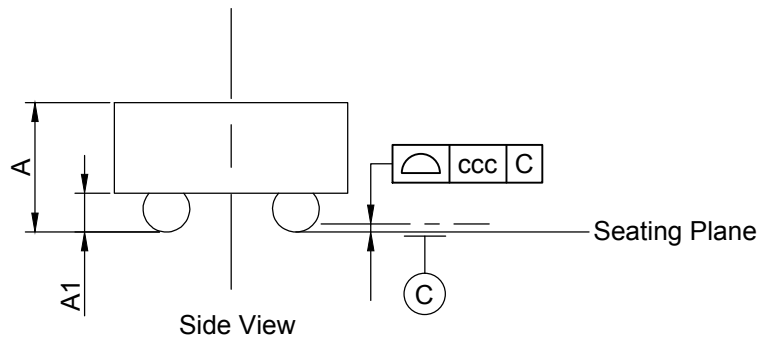


Top View



Bottom View



Side View

| PKG. DIMENSIONS(MM) |           |       |
|---------------------|-----------|-------|
| SYMBOL              | Min       | Max   |
| A                   | 0.455     | 0.545 |
| A1                  | 0.150     | 0.190 |
| D                   | 1.915     | 1.965 |
| e                   | 0.500 BSC |       |
| E                   | 0.925     | 0.975 |
| b                   | 0.215     | 0.255 |
| ccc                 | 0.080 TYP |       |

**Note:**  
1. Ref:JEDEC MO-211C .



DATE: 06/18/13

DESCRIPTION: 8-Pin, CSP, 0.95X1.94, Wafer Level

PACKAGE CODE: GA (GA8)

DOCUMENT CONTROL#: PD-2155

REVISION: --